

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	85	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage	V _{R(RMS)}	57	V
Forward Continuous Current	I _{FM}	300	mA
Average Rectified Output Current	I ₀	100	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs	I _{FSM}	2.0	Α

Thermal Characteristics

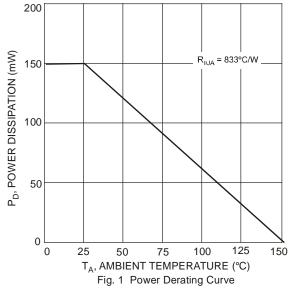
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	150	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{0JA}	833	°C/W
Operating and Storage Temperature Range	T_J,T_STG	-65 to +150	°C

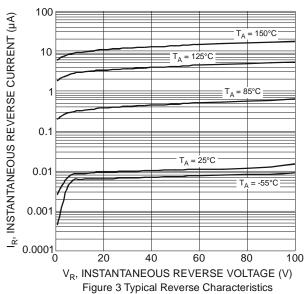
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

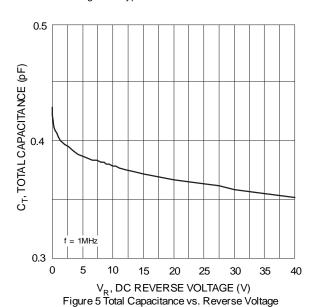
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	80	_	I	V	$I_R = 100 \mu A$
Forward Voltage	V _F	111	0.62 0.74 0.94	0.7 0.82 1.20	V	$\begin{split} I_F &= 1.0 \text{mA} \\ I_F &= 10 \text{mA} \\ I_F &= 100 \text{mA} \end{split}$
Leakage Current (Note 6)	I _R	111111	5 — — — —	10.0 0.4 0.1 0.6 0.2 0.8	μΑ μΑ μΑ	$V_R = 5V$ $V_R = 5V, T_J = +85^{\circ}C$ $V_R = 30V$ $V_R = 30V, T_J = +85^{\circ}C$ $V_R = 80V$ $V_R = 80V, T_J = +85^{\circ}C$
Total Capacitance	Ст	_	0.5	2.5	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}		_ _	4.0 4.0	ns ns	$\begin{split} I_F &= 10 m A, \ V_R = 6 V \\ I_F &= I_R = 10 m A, \\ I_{rr} &= 0.1 \ x \ I_R, \ R_L = 100 \Omega \end{split}$

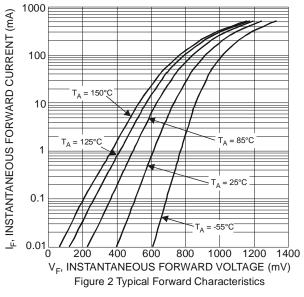
5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com. 6. Short duration pulse test used to minimize self-heating effect. Notes:

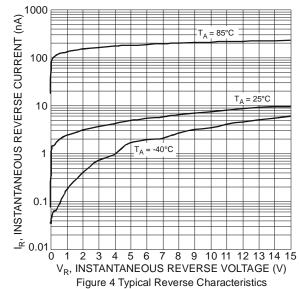








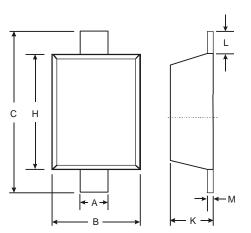






Package Outline Dimensions

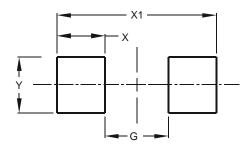
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD523			
Dim	Min	Max	
Α	0.25	0.35	
В	0.70	0.90	
С	1.50	1.70	
Н	1.10	1.30	
K	0.55	0.65	
L	0.10	0.30	
M	0.10	0.12	
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Υ	0.70



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